

Description

The STD25NF10LT4 uses advanced trench technology

to provide excellent R_{DS(ON)}, low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.



TO-252-2L

General Features

 $V_{DS} = 100V I_{D} = 30A$

 $R_{DS(ON)}$ < 48m Ω @ V_{GS} =10V



Battery protection

Load switch N-Channel MOSFET

Uninterruptible power supply

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|--------------|-----------|------------|----------|
| STD25NF10LT4 | TO-252-2L | HXY MOSFET | 2500 |

Absolute Maximum Ratings Tc=25°C unless otherwise noted

| Symbol | Parameter | Rating | Units | |
|---------------------------------------|--------------------------------------------------------------|-----------------------------------------------------------|-------|--|
| VDS | Drain-Source Voltage | 100 | V | |
| Vgs | Gate-Source Voltage | Gate-Source Voltage ±20 | | |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | , V _{GS} @ 10V ¹ 30 | | |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | uous Drain Current, V _{GS} @ 10V ¹ 13 | | |
| Ірм | Pulsed Drain Current ² | 80 | Α | |
| EAS | Single Pulse Avalanche Energy ³ | ralanche Energy ³ 30 | | |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | Power Dissipation ⁴ 42 | | |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C | |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C | |
| R _θ JC | Thermal Resistance Junction-Case ¹ | 3.6 | °C/W | |



Electrical Characteristics (T_J=25°C unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|----------------------|--------------------------------------------------|---------------------------------------------|------|------|------|-------|
| Off Charac | cteristic | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 100 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =100V, V _{GS} =0V, | - | - | 1.0 | μA |
| I _{GSS} | Gate to Body Leakage Current | V _{DS} =0V, V _{GS} =±20V | - | - | ±100 | nA |
| On Charac | cteristics | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_{D}=250\mu A$ | 1.0 | 1.5 | 2.2 | V |
| Б | Static Drain-Source on-Resistance | V _{GS} =10V, I _D =10A | - | 37 | 48 | mΩ |
| $R_{DS(on)}$ | | V _{GS} =4.5V, I _D =6A | - | 39 | 55 | mΩ |
| Dynamic C | Characteristics | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =25V, V _{GS} =0V, | _ | 1964 | - | pF |
| Coss | Output Capacitance | | - | 90 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | f=1.0MHz | - | 74 | - | pF |
| Qg | Total Gate Charge | V _{DS} =80V, I _D =20A, | - | 20 | - | nC |
| Q _{gs} | Gate-Source Charge | | - | 3.1 | - | nC |
| \mathbf{Q}_{gd} | Gate-Drain("Miller") Charge | V _{GS} =4.5V | - | 14 | - | nC |
| Switching | Characteristics | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | | - | 11 | - | ns |
| t _r | Turn-on Rise Time | V_{DS} =80V, I_{D} =20A, | - | 91 | - | ns |
| t _{d(off)} | Turn-off Delay Time | R _G =3.1Ω, V _{GS} =4.5V | - | 40 | - | ns |
| t _f | Turn-off Fall Time | | - | 71 | - | ns |
| Drain-Sou | rce Diode Characteristics and Maxim | um Ratings | | | | |
| 1 | Maximum Continuous Drain to Source Diode Forward | | | | 07 | Δ |
| Is | Current | - | | - | 27 | Α |
| I _{SM} | Maximum Pulsed Drain to Source Dio | de Forward Current | - | - | 80 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | V _{GS} =0V, I _S =20A | - | _ | 1.2 | ٧ |
| trr | Body Diode Reverse Recovery Time | | _ | 64 | _ | ns |
| Qrr | Body Diode Reverse Recovery Charge | l _F =20A, dl/dt=100A/μs | - | 152 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition : T_J=25 $^{\circ}\text{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω ,I_AS= 11A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



Typical Performance Characteristics

Figure1: Output Characteristics

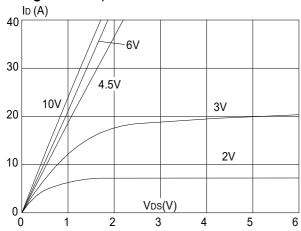


Figure 2: Typical Transfer Characteristics

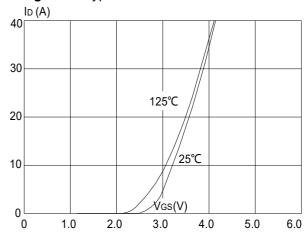


Figure 3:On-resistance vs. Drain Current

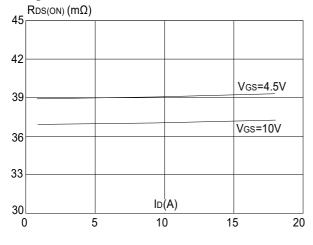


Figure 4: Body Diode Characteristics

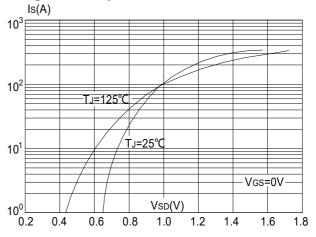


Figure 5: Gate Charge Characteristics

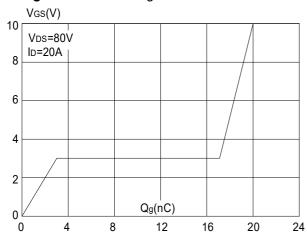


Figure 6: Capacitance Characteristics

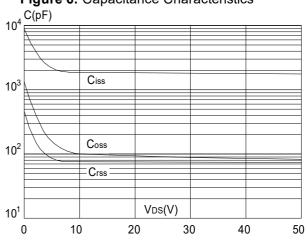




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

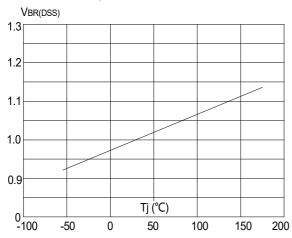


Figure 9: Maximum Safe Operating Area

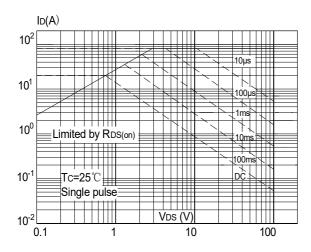


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

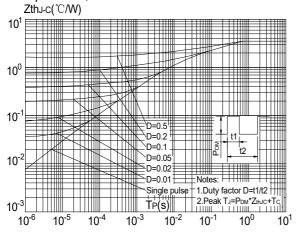


Figure 8: Normalized on Resistance vs. Junction Temperature

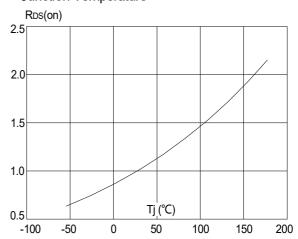
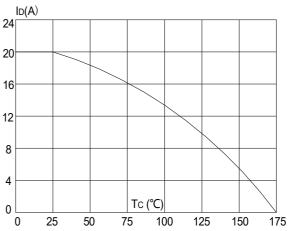
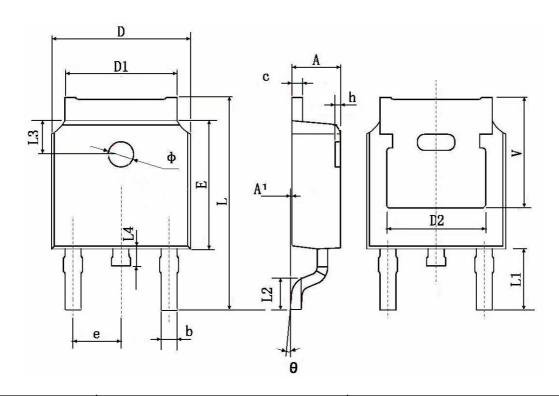


Figure 10: Maximum Continuous Drain Current vs. Case Temperature





TO-252-2L Package Information



| | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|-------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| А | 2.200 | 2.400 | 0.087 | 0.094 | |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 | |
| b | 0.660 | 0.860 | 0.026 | 0.034 | |
| С | 0.460 | 0.580 | 0.018 | 0.023 | |
| D | 6.500 | 6.700 | 0.256 | 0.264 | |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 | |
| D2 | 0.483 TYP. | | 0.190 TYP. | | |
| Е | 6.000 | 6.200 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.800 | 10.400 | 0.386 | 0.409 | |
| L1 | 2.900 TYP. | | 0.114 TYP. | | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 | |
| L3 | 1.600 TYP. | | 0.063 TYP. | | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 | |
| Ф | 1.100 | 1.300 | 0.043 | 0.051 | |
| θ | 0° | 8° | 0° | 8° | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| V | 5.350 TYP. | | 0.211 TYP. | | |



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